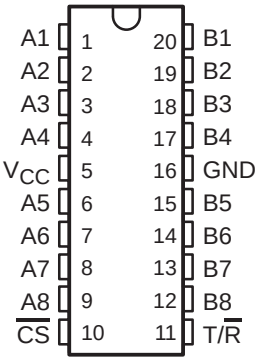
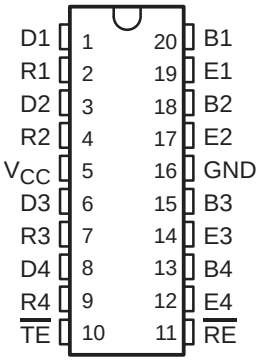
SLLS028G – AUGUST 1987 – REVISED JUNE 1998

- **Suitable for IEEE Standard 896 Applications†**
- **SN75ALS056 is an Octal Transceiver**
- **SN75ALS057 is a Quad Transceiver**
- **High-Speed Advanced Low-Power Schottky (ALS) Circuitry**
- **Low Power Dissipation:**
  52.5 mW/Channel Max
- **High-Impedance pnp Inputs**
- **Logic-Level 1-V Bus Swing Reduces Power Consumption**
- **Trapezoidal Bus Output Waveform Reduces Noise Coupling to Adjacent Lines**
- **Power-Up/Power-Down Protection (Glitch Free)**
- **Open-Collector Driver Outputs Allow Wired-OR Connections**
- **Designed to Be a Faster, Lower-Power Functional Equivalent of National DS3896, DS3897**

SN75ALS056 . . . DW OR N PACKAGE
(TOP VIEW)



SN75ALS057 . . . DW OR N PACKAGE
(TOP VIEW)



description

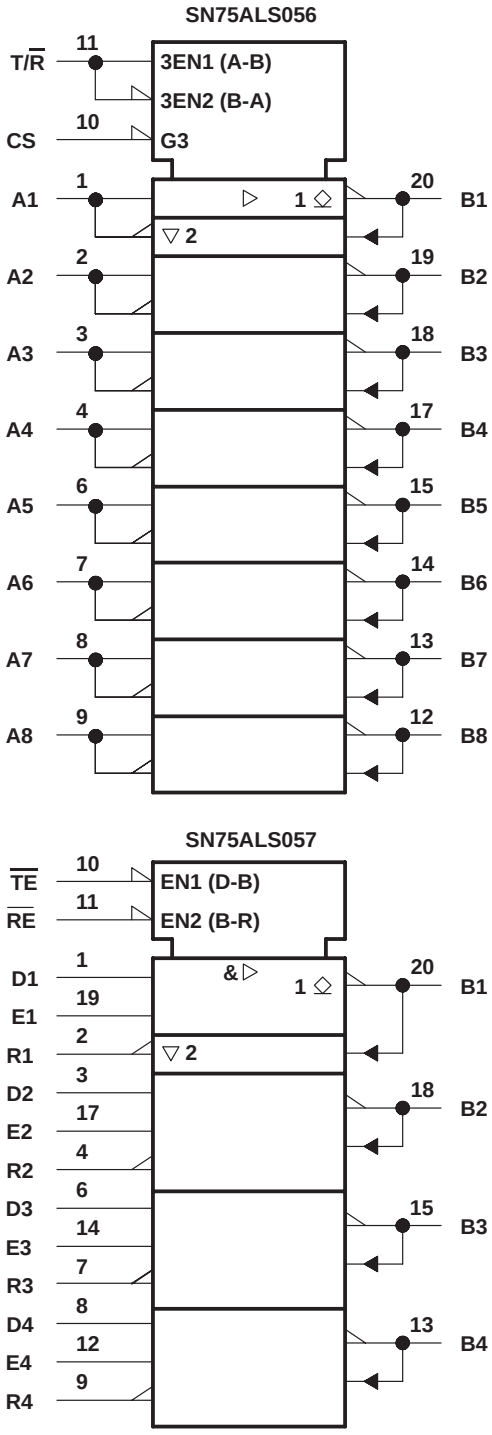
The SN75ALS056 is an eight-channel, monolithic, high-speed, advanced low-power Schottky (ALS) device designed for two-way data communication in a densely populated backplane. The SN75ALS057 is a four-channel version with independent driver-input (Dn) and receiver-output (Rn) pins and a separate driver disable for each driver (En).

These transceivers feature open-collector driver outputs with series Schottky diodes to reduce capacitive loading to the bus. By using a 2-V pullup termination on the bus, the output signal swing is approximately 1 V, which reduces the power necessary to drive the bus load capacitance. The driver outputs generate trapezoidal waveforms that reduce crosstalk between channels. The drivers are capable of driving an equivalent dc load as low as 18.5 Ω. The receivers have internal low-pass filters to further improve noise immunity.

The SN75ALS056 and SN75ALS057 are characterized for operation from 0°C to 70°C.

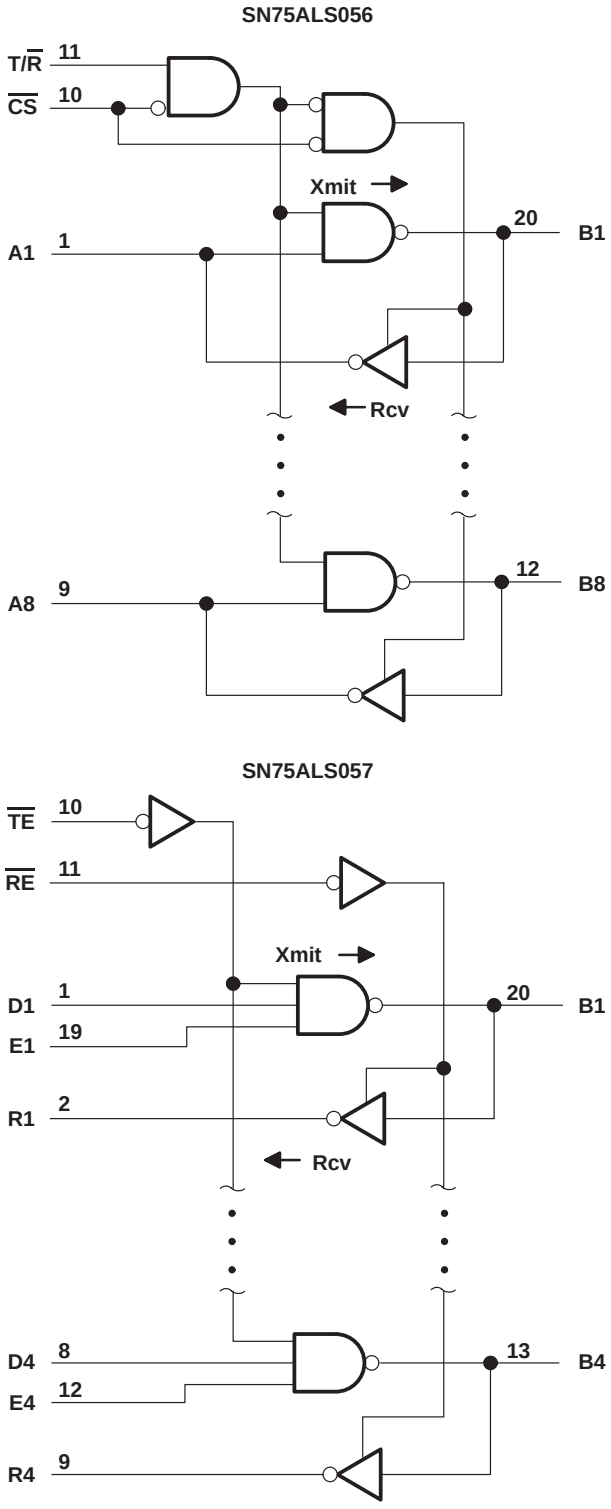
† The transceivers are suitable for IEEE Standard 896 applications to the extent of the operating conditions and characteristics specified in this data sheet.

logic symbol†



† These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



† These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Function Tables

SN75ALS056
TRANSMIT/RECEIVE

CONTROLS		CHANNELS
$\overline{CS}$	T/$\overline{R}$	A ↔ B
L	H	T(A B)
L	L	R(B A)
H	X	D

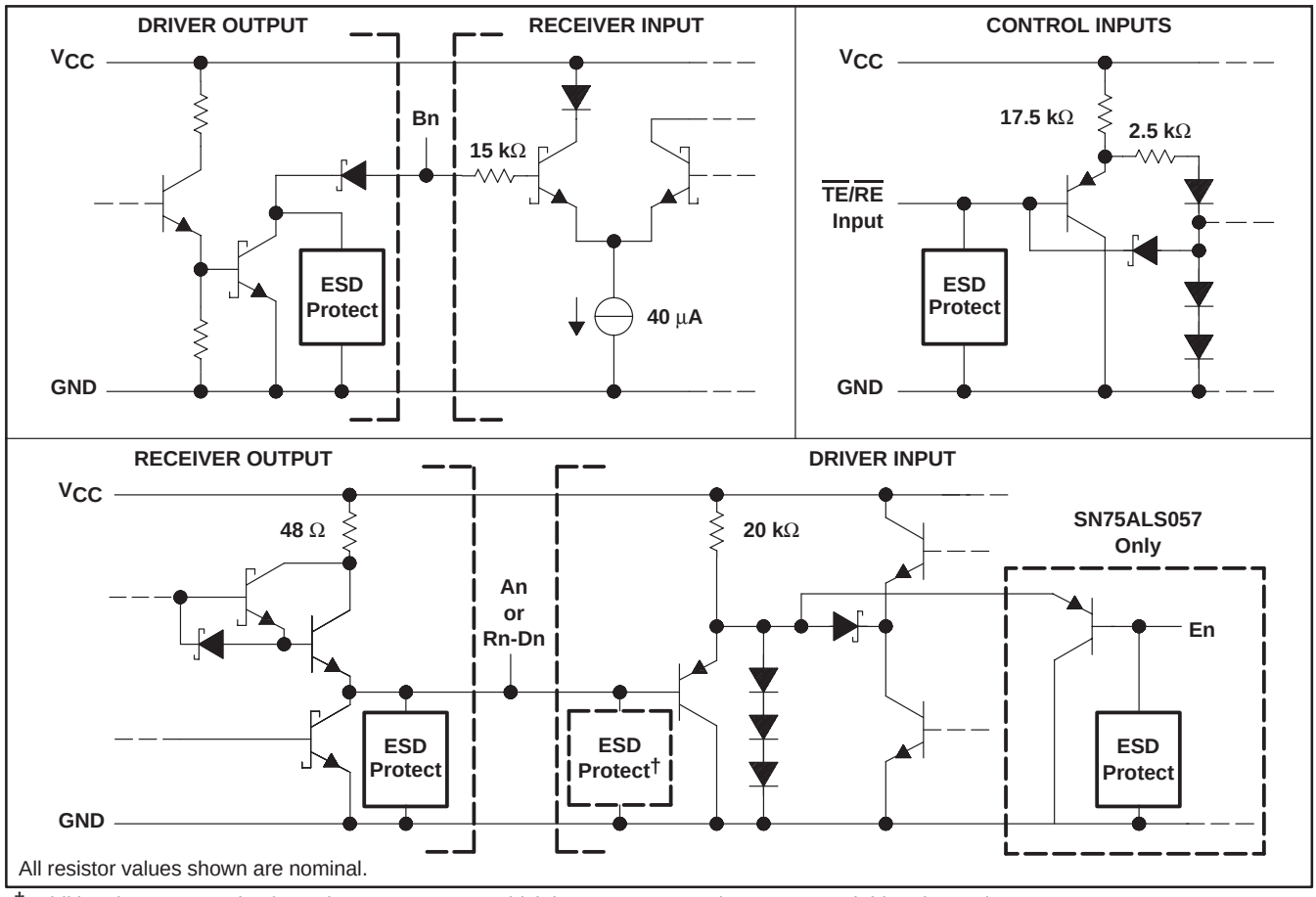
SN75ALS057
TRANSMIT/RECEIVE

CONTROLS			CHANNELS			
$\overline{TE}$	$\overline{RE}$	En	D	B	B	R
L	L	L	D			R
L	L	H	T			R
L	H	L	D			D
L	H	H	T			D
H	L	X	D			R
H	H	X	D			D

H = high level, L = low level, R = receive, T = transmit,
D = disable, X = irrelevant

Direction of data transmission is from An to Bn for the SN75ALS056 and from Dn to Bn for the SN75ALS057. Direction of data reception is from Bn to An for the SN75ALS056 and from Bn to Rn for the SN75ALS057. Data transfer is inverting in both directions.

schematics of inputs and outputs



All resistor values shown are nominal.

† Additional ESD protection is on the SN75ALS057, which has separate receiver-output and driver-input pins.

absolute maximum ratings over operating free-air temperature (unless otherwise noted)‡

Supply voltage, V_{CC} (see Note 1) . . . . . 6 V
Control input voltage, V_I . . . . . 5.5 V
Driver input voltage, V_I . . . . . 5.5 V
Driver output voltage, V_O . . . . . 2.5 V
Receiver input voltage, V_I . . . . . 2.5 V
Receiver output voltage, V_O . . . . . 5.5 V
Continuous total power dissipation . . . . . See Dissipation Rating Table
Storage temperature range, T_{stg} . . . . . –65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: DW or N package . . . . . 260 °C

‡ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: Voltage values are with respect to network ground terminal.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25°C$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25°C$	$T_A = 70°C$ POWER RATING	$T_A = 125°C$ POWER RATING
DW	1025 mW	8.2 mW/°C	656 mW	—
N	1150 mW	9.2 mW/°C	736 mW	—

recommended operating conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}	4.75	5	5.25	V
High-level driver and control input voltage, V_{IH}	2			V
Low-level driver and control input voltage, V_{IL}			0.8	V
Bus termination voltage	1.9		2.1	V
Operating free-air temperature, T_A	0		70	°C

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER			TEST CONDITIONS†	SN75ALS056			UNIT
				MIN	TYP†	MAX	
V_{IK}	Input clamp voltage at An, T/$\overline{R}$, or $\overline{CS}$		I_I = –18 mA			–1.5	V
V_{IT}	Receiver input threshold voltage at Bn			1.405		1.69	V
V_{OH}	High-level output voltage at An		Bn at 1.2 V, $\overline{CS}$ at 0.8 V, T/$\overline{R}$ at 0.8V, I_{OH} = – 400 μA	2.4			V
V_{OL}	Low-level output voltage	An	Bn at 2 V ,$\overline{CS}$ at 0.8 V, T/$\overline{R}$ at 0.8 V, I_{OL} = 16 mA			0.5	V
		Bn	An at 2 V, $\overline{CS}$ at 0.8 V, T/$\overline{R}$ at 2 V, V_L = 2 V, R_L =18.5 Ω,, See Figure 1	0.75		1.2	
I_{IH}	High-level input current	An, T/$\overline{R}$ or $\overline{CS}$	$V_I = V_{CC}$			40	μA
		Bn	V_I = 2 V, V_{CC} = 0 or 5.25 V, An at 0.8 V, T/$\overline{R}$ at 0.8 V			100	
I_{IL}	Low level input current at An, T/$\overline{R}$, or $\overline{CS}$		V_I = 0.4 V			–400	μA
I_{OS}	Short-circuit output current at An		An at 0, Bn at 1.2 V, $\overline{CS}$ at 0.8 V, T/$\overline{R}$ at 0.8 V	–40		–120	mA
I_{CC}	Supply current					75	mA
$C_{O(B)}$	Driver output capacitance				4.5		pF

† Typical values are at V_{CC} = 5 V, T_A = 25°C.

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER			TEST CONDITIONS	SN75ALS057			UNIT
				MIN	TYP†	MAX	
V_{IK}	Input clamp voltage at Dn, En, $\overline{TE}$, or $\overline{RE}$		I_I = –18 mA			–1.5	V
V_{IT}	Receiver input threshold voltage at Bn			1.41		1.69	V
V_{OH}	High-level output voltage at Rn		Bn at 1.2 V, $\overline{RE}$ at 0.8 V, I_{OH} = –400 μA	2.4			V
V_{OL}	Low-level output voltage	Rn	Bn at 2 V, $\overline{RE}$ at 0.8 V, I_{OL} = 16 mA			0.5	V
		Bn	Dn at 2 V, En at 2 V, $\overline{TE}$ at 0.8 V, V_L = 2 V, R_L = 18.5 Ω, See Figure 1	0.75		1.2	
I_{IH}	High-level input current	Dn, En, $\overline{TE}$, or $\overline{RE}$	$V_I = V_{CC}$			40	μA
		Bn	V_I = 2 V, V_{CC} = 0 or 5.25 V, Dn at 0.8 V, En at 0.8 V, $\overline{TE}$ at 0.8 V			100	
I_{IL}	Low-level input current at Dn, En, $\overline{TE}$, or $\overline{RE}$		V_I = 0.4 V			–400	μA
I_{OS}	Short-circuit output current at Rn		Rn at 0, Bn at 1.2 V, $\overline{RE}$ at 0.8 V	–40		–120	mA
I_{CC}	Supply current					40	mA
$C_{O(B)}$	Driver output capacitance				4.5		pF

† Typical values are at V_{CC} = 5 V, T_A = 25°C.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	SN75ALS056 DRIVER			UNIT
					MIN	TYP†	MAX	
t_{PLH1}	Propagation delay time, low-to-high-level output	$\overline{CS}$	Bn	An and T/$\overline{R}$ at 2 V, V_L = 2 V, R_L1 = 18 Ω,, C_L = 30 pF, R_L2 not connected, See Figure 2			24	ns
t_{PHL1}	Propagation delay time, high-to-low-level output						20	
t_{PLH2}	Propagation delay time, low-to-high-level output	An	Bn	$\overline{CS}$ at 0.8 V, T/$\overline{R}$ at 2 V, V_L = 2 V, R_L1 = 18 Ω,, R_L2 not connected, C_L = 30 pF, See Figure 2,			19	ns
t_{PHL2}	Propagation delay time high-to-low-level output						18	
t_{PLH3}	Propagation delay time, low-to-high-level output	T/$\overline{R}$	Bn	$V_{I(An)}$ = 5 V, CS at 0.8 V, R_L1 = 18 Ω, C_L = 30 pF, R_L2 not connected, V_L = 2 V, See Figure 3,			25	ns
t_{PHL3}	Propagation delay time, high-to-low-level output						35	
t_{TLH}	Transition time, low-to-high-level output	An	Bn	$\overline{CS}$ at 0.8 V, T/$\overline{R}$ at 2 V, V_L = 2 V, C_L = 30 pF, R_L1 = 18 Ω, R_L2 not connected, See Figure 2	1	3	11	ns
t_{THL}	Transition time, high-to-low-level output				1	3	6	

† Typical values are at V_{CC} = 5 V, T_A = 25°C

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	SN75ALS056 RECEIVER		UNIT
					MIN	MAX	
t_{PLH4}	Propagation delay time, low-to-high-level output	Bn	An	$\overline{CS}$ at 0.8 V, T/$\overline{R}$ at 0.8 V, R_L1 = 390 Ω, R_L2 = 1.6 kΩ, C_L = 30 pF, See Figure 4		18	ns
t_{PHL4}	Propagation delay time, high-to-low-level output					18	
t_{PLZ1}	Output disable time from low level	T/$\overline{R}$	An	$\overline{CS}$ at 0.8 V, $V_{I(Bn)}$ = 2 V, V_L = 5 V, R_L1 = 390 Ω, R_L2 not connected, C_L = 15 pF, See Figure 3		20	ns
t_{PZL1}	Output enable time to low level	T/$\overline{R}$	An	$\overline{CS}$ at 0.8 V, $V_{I(Bn)}$ = 2 V, V_L = 5 V, R_L1 = 390 Ω, R_L2 = 1.6 kΩ, C_L = 30 pF, See Figure 3		40	ns
t_{PHZ1}	Output disable time from high level	T/$\overline{R}$	An	$\overline{CS}$ at 0.8 V, $V_{I(Bn)}$ = 0, V_L = 0, R_L1 = 390 Ω, R_L2 not connected, C_L = 15 pF, See Figure 3		17	ns
t_{PZH1}	Output enable time to high level	T/$\overline{R}$	An	$\overline{CS}$ at 0.8 V, $V_{I(Bn)}$ = 0, V_L = 0, R_L1 not connected, R_L2 = 1.6 kΩ, C_L = 30 pF, See Figure 3		15	ns
t_{PLZ2}	Output disable time from low level	$\overline{CS}$	An	Bn at 2 V, T/$\overline{R}$ at 0.8 V, C_L = 5 pF, V_L = 5 V, R_L1 = 390 Ω, R_L2 not connected, See Figure 5		18	ns
t_{PZL2}	Output enable time to low level	$\overline{CS}$	An	Bn at 2 V, T/$\overline{R}$ at 0.8 V, C_L = 30 pF, V_L = 5 V, R_L1 = 390 Ω, R_L2 = 1.6 kΩ, See Figure 5		15	ns
t_{PHZ2}	Output disable time from high level	$\overline{CS}$	An	Bn at 0.8 V, T/$\overline{R}$ at 0.8 V, C_L = 5 pF, V_L = 0, R_L1 = 390 Ω, R_L2 not connected, See Figure 5		8	ns
t_{PZH2}	Output enable time to high level	$\overline{CS}$	An	Bn at 0.8 V, T/$\overline{R}$ at 0.8 V, C_L = 30 pF, V_L = 0, R_L1 not connected, R_L2 = 1.6 kΩ, See Figure 5		17	ns
$t_{w(NR)}$	Receiver noise rejection pulse duration	Bn	An	$\overline{CS}$ at 0.8 V, T/$\overline{R}$ at 0.8 V, R_L1 = 390 Ω, R_L2 = 1.6 kΩ, C_L = 30 pF, V_L = 5 V, See Figure 6	3		ns

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	SN75ALS057 DRIVER			UNIT
					MIN	TYP†	MAX	
t_{PLH1}	Propagation delay time, low-to-high-level output	$\overline{TE}$	Bn	Dn, En, $\overline{RE}$ at 2 V, V_L = 2 V, R_L2 not connected, R_L1 = 18 Ω, See Figure 2, C_L = 30 pF			24	ns
t_{PHL1}	Propagation delay time, high-to-low-level output						20	
t_{PLH2}	Propagation delay time, low-to-high-level output	Dn or En	Bn	$\overline{TE}$ at 0.8 V, $\overline{RE}$ at 2 V, V_L = 2 V, R_L1 = 18 Ω, R_L2 not connected, C_L = 30 pF, See Figure 2			19	ns
t_{PHL2}	Propagation delay time, high-to-low-level output						18	
t_{TLH}	Transition time, low-to-high-level output	Dn or En	Bn	$\overline{RE}$ at 2 V, V_L = 2 V, $\overline{TE}$ at 0.8 V, R_L1 = 18 Ω,, R_L2 not connected, C_L = 30 pF, See Figure 2	1	3	11	ns
t_{THL}	Transition time, high-to-low-level output				1	3	6	

† Typical values are at V_{CC} = 5 V, T_A = 25°C.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	SN75ALS057 RECEIVER		UNIT
					MIN	MAX	
t_{PLH4}	Propagation delay time, low-to-high-level output	Bn	Rn	$\overline{RE}$ at 0.8 V, $\overline{TE}$ at 2 V, V_L = 5 V, R_L1 = 390 Ω,, R_L2 = 1.6 kΩ,, C_L = 30 pF, See Figure 4		18	ns
t_{PHL4}	Propagation delay time, high-to-low-level output					18	
t_{PLZ2}	Output disable time from low level	$\overline{RE}$	Rn	Bn at 2 V, $\overline{TE}$ at 2 V, V_L = 5 V, C_L = 5 pF, R_L1 = 390 Ω, R_L2 not connected, See Figure 5		18	ns
t_{PZL2}	Output enable time to low level	$\overline{RE}$	Rn	Bn at 2 V, $\overline{TE}$ at 2 V, V_L = 5 V, C_L = 30 pF, R_L1 = 390 Ω, R_L2 = 1.6 kΩ, See Figure 5		15	ns
t_{PHZ2}	Output disable time from high level	$\overline{RE}$	Rn	Bn at 0.8 V, $\overline{TE}$ at 2 V, V_L = 0, C_L = 5 pF, R_L1 = 390 Ω, R_L2 not connected, See Figure 5		17	ns
t_{PZH2}	Output enable time to high level	$\overline{RE}$	Rn	Bn at 0.8 V, $\overline{TE}$ at 2 V, V_L = 0, C_L = 30 pF, R_L1 not connected, R_L2 = 1.6 kΩ, See Figure 5		17	ns
$t_{w(NR)}$	Receiver noise rejection pulse duration	Bn	Rn	$\overline{TE}$ at 2 V, $\overline{RE}$ at 0.8 V, V_L = 0, R_L1 = 390 Ω, R_L2 = 1.6 kΩ, C_L = 30 pF, See Figure 6	3		ns

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	SN75ALS057 DRIVER PLUS RECEIVER		UNIT
					MIN	MAX	
t_{PLH6}	Propagation delay time, low-to-high-level output	Dn	Rn	$\overline{RE}$ at 0.8 V, $\overline{TE}$ at 0.8 V, R_L1 = 390 Ω, R_L2 = 1.6 kΩ,, C_L = 30 pF, See Figure 7		40	ns
t_{PHL6}	Propagation delay time, high-to-low-level output					40	

PARAMETER MEASUREMENT INFORMATION

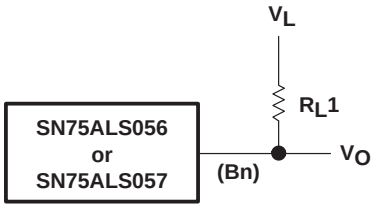
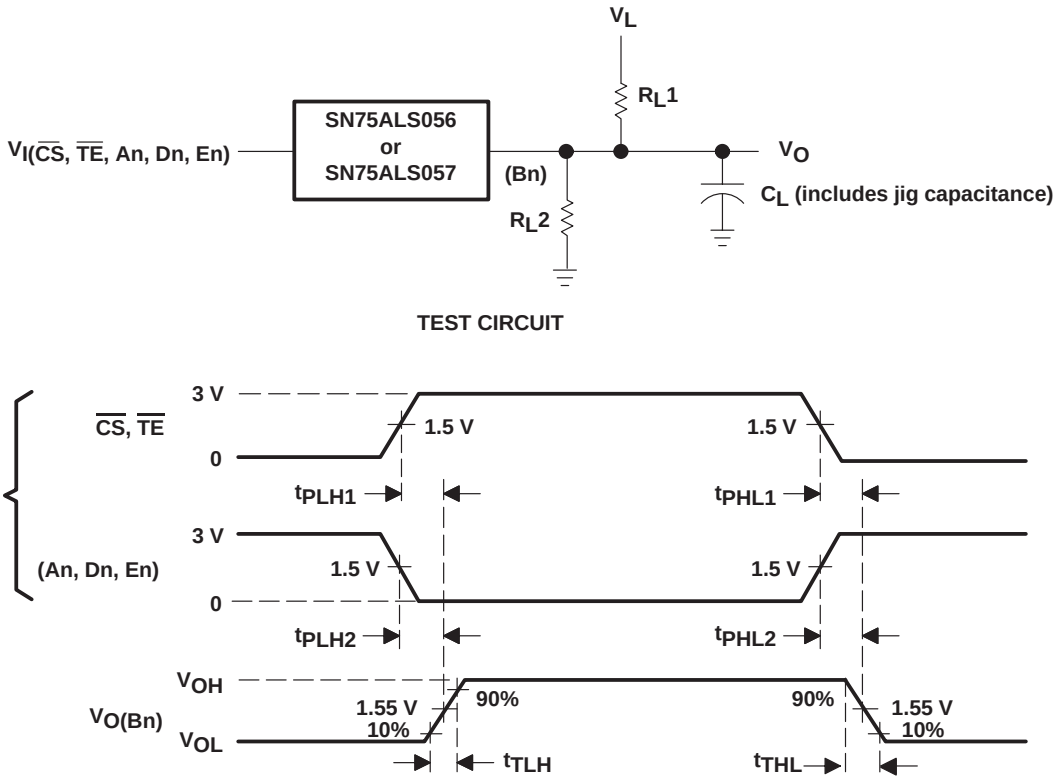


Figure 1. Driver Low-Level-Output-Voltage Test Circuit

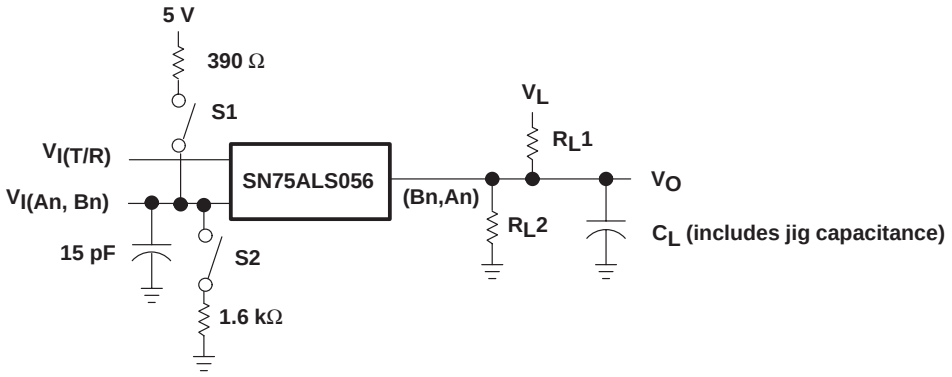
PARAMETER MEASUREMENT INFORMATION



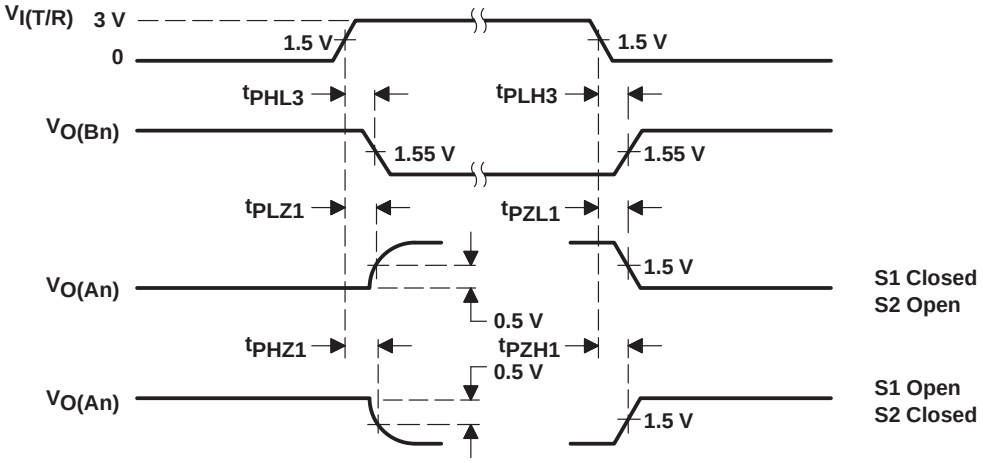
NOTE A: $t_r = t_f \leq 5$ ns from 10% to 90%

Figure 2. Driver Test Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION



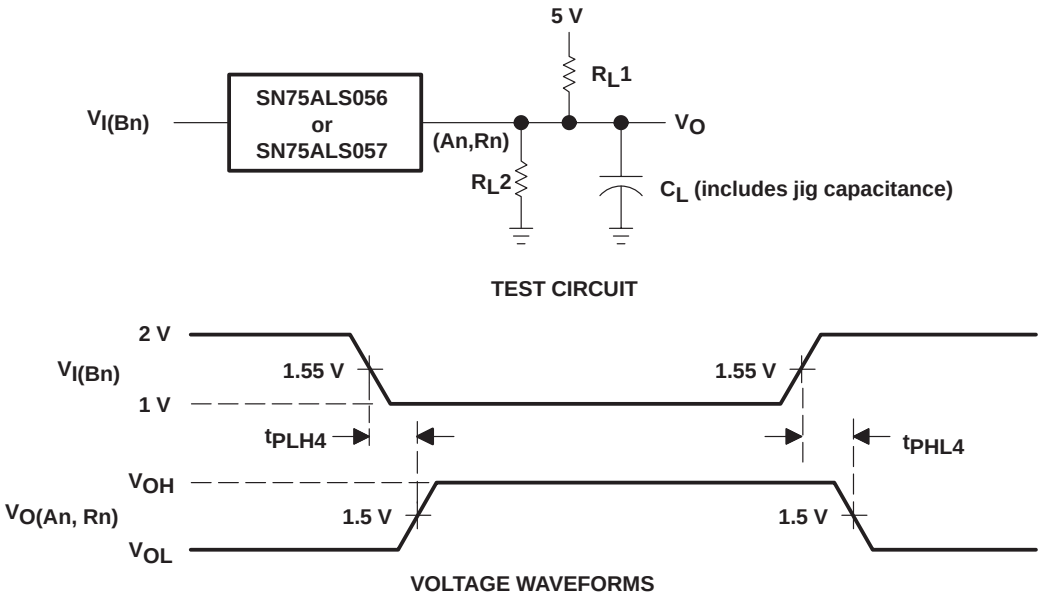
TEST CIRCUIT



VOLTAGE WAVEFORMS

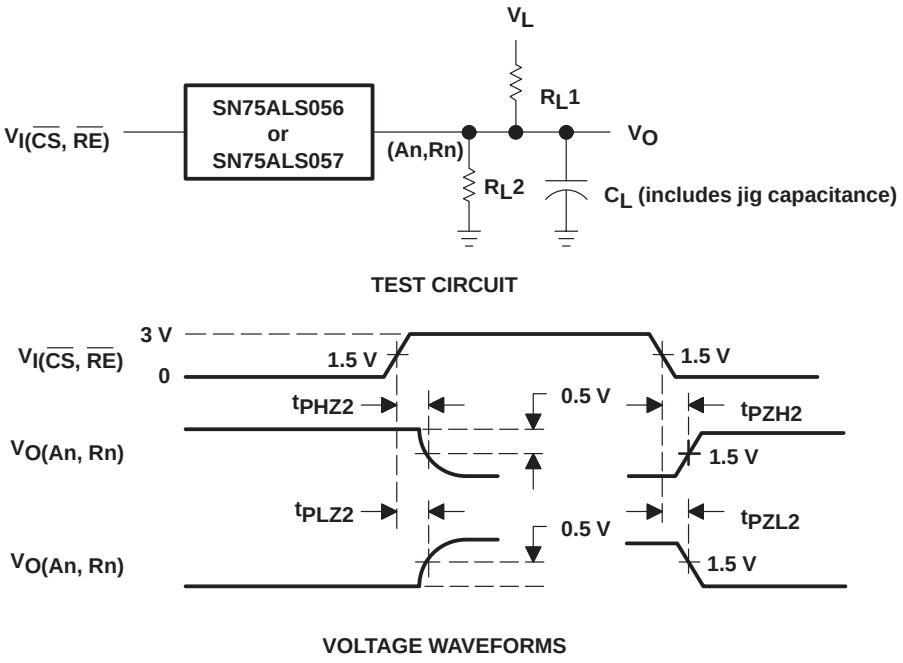
NOTE A: $t_r = t_f \leq 5$ ns from 10% to 90%

Figure 3. Propagation Delay From T/$\overline{R}$ to An or Bn Test Circuit and Voltage Waveforms



NOTE A: $t_r = t_f \leq 5$ ns from 10% to 90%

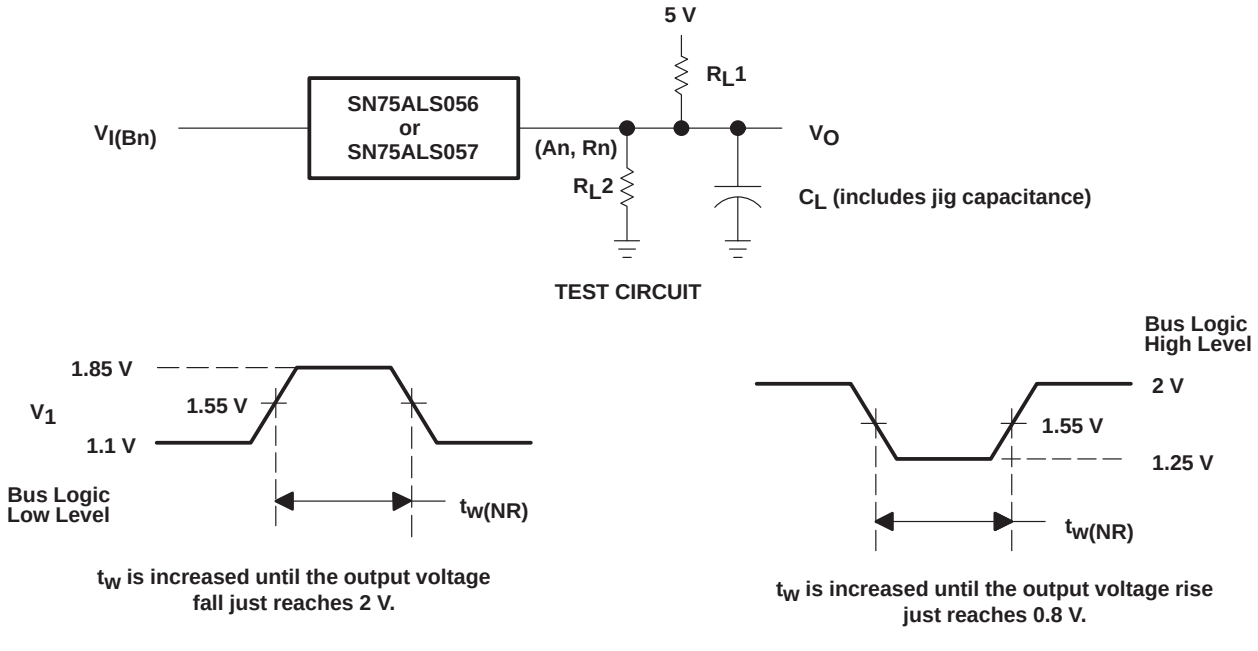
Figure 4. Receiver Test Circuit and Voltage Waveforms



NOTE A: $t_r = t_f \leq 5$ ns from 10% to 90%

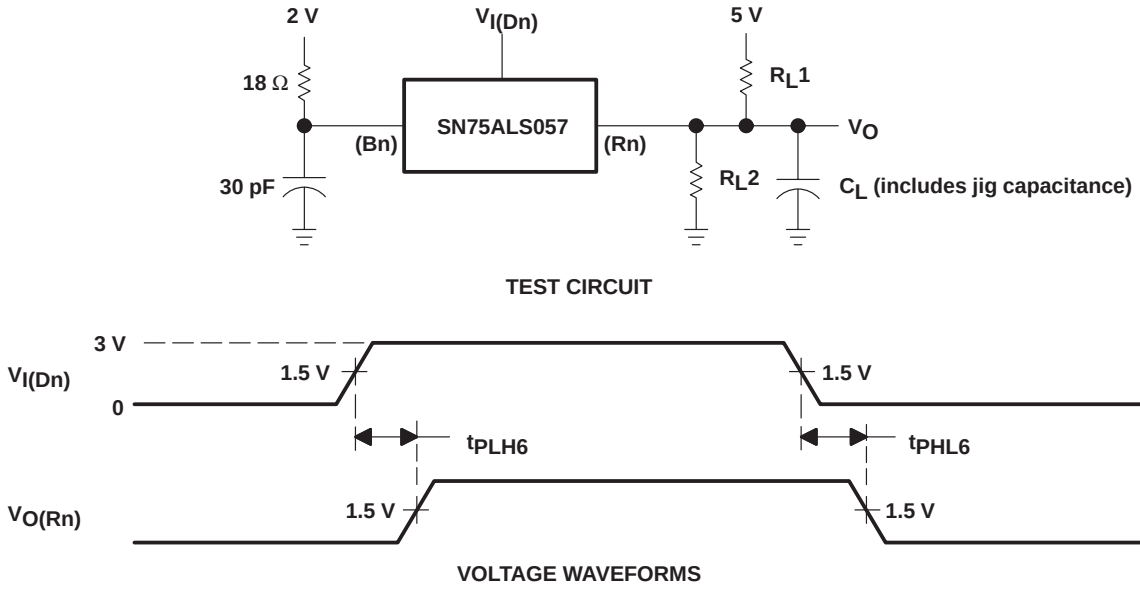
Figure 5. Propagation Delay From $\overline{CS}$ to An or $\overline{RE}$ to Rn Test Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION



NOTE A: $t_r = t_f \leq 5$ ns from 10% to 90%

Figure 6. Receiver Noise-Immunity Test Circuit and Voltage Waveforms



NOTE A: $t_r = t_f \leq 5$ ns from 10% to 90%

Figure 7. Driver Plus Receiver Delay-Times Test Circuits and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
SN75ALS056DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS056DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS056DWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS056N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75ALS056NE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75ALS057DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS057DWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS057DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS057DWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75ALS057N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75ALS057NE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

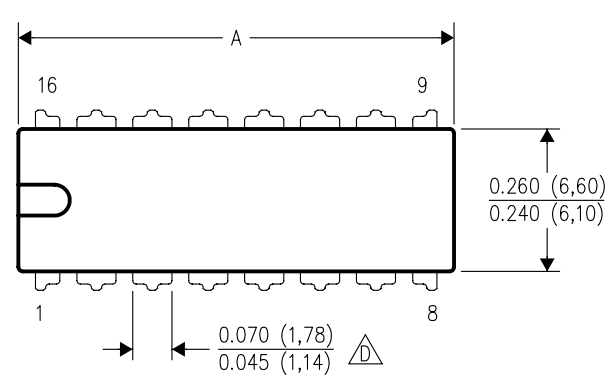
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

to Customer on an annual basis.

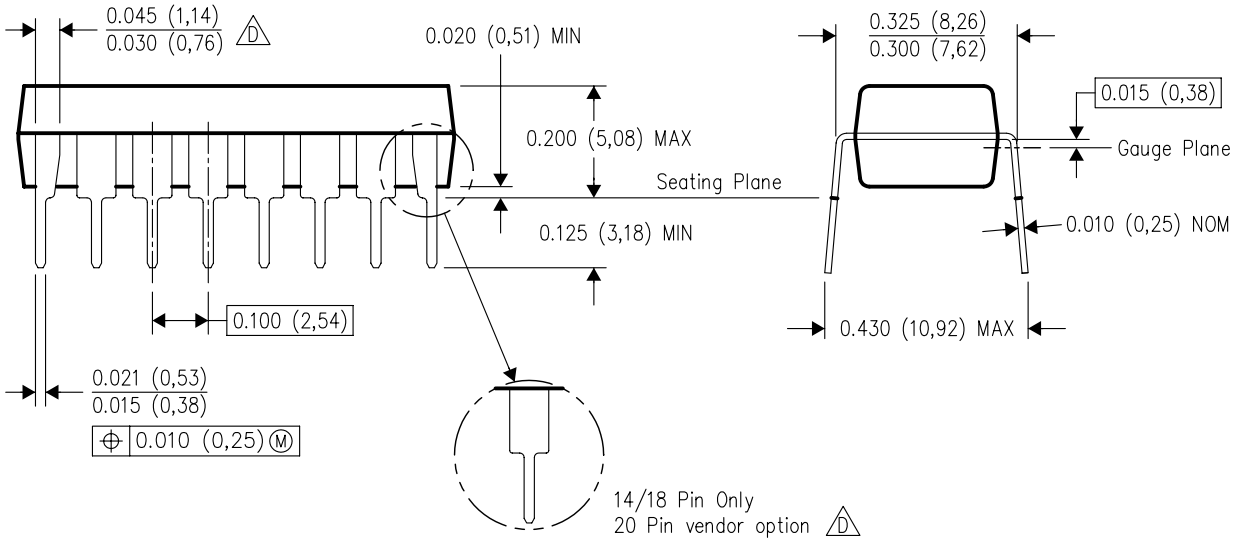
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



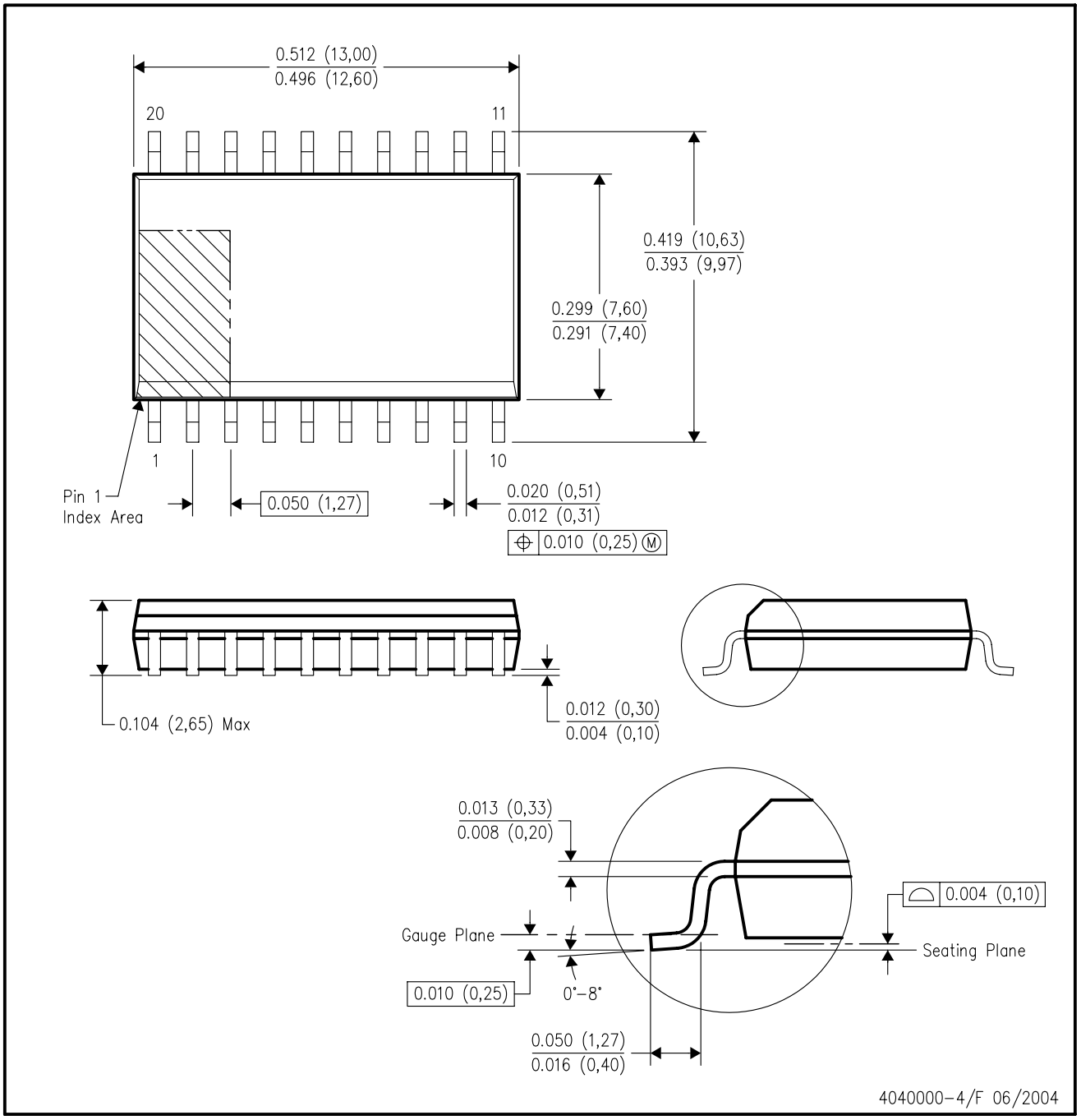
DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW (R–PDSO–G20) PLASTIC SMALL–OUTLINE PACKAGE



NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
D. Falls within JEDEC MS–013 variation AC.

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